

# 74AUP1G175

Low-power D-type flip-flop with reset; positive-edge trigger

Rev. 01.mm — 27 March 2006

Preliminary data sheet

## 1. General description

The 74AUP1G175 is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

Schmitt-trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74AUP1G175 is a single positive edge triggered D-type flip-flop with individual data (D) input, clock (CP) input, master reset ( $\overline{MR}$ ) input, and Q output. The master reset ( $\overline{MR}$ ) is an asynchronous active LOW input and operates independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D input must be stable one set-up time prior to the LOW-to-HIGH clock transition, for predictable operation.

## 2. Features

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - ◆ JESD8-12 (0.8 V to 1.3 V)
  - ◆ JESD8-11 (0.9 V to 1.65 V)
  - ◆ JESD8-7 (1.2 V to 1.95 V)
  - ◆ JESD8-5 (1.8 V to 2.7 V)
  - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114-C Class 3A. Exceeds 5000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
  - ◆ CDM JESD22-C101-C exceeds 1000 V
- Low static power consumption;  $I_{CC} = 0.9 \mu\text{A}$  (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of  $V_{CC}$
- $I_{OFF}$  circuitry provides partial Power-down mode operation

**PHILIPS**

- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$

### 3. Quick reference data

**Table 1: Quick reference data**

$GND = 0\text{ V}$ ;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $t_r = t_f \leq 3\text{ ns}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$t_{PHL}$ , $t_{PLH}$	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 0.8\text{ V}$	-	21.1	-	ns	
		$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 1.1\text{ V to }1.3\text{ V}$	2.4	5.9	11.7	ns	
		$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 1.4\text{ V to }1.6\text{ V}$	2.0	4.1	6.8	ns	
		$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 1.65\text{ V to }1.95\text{ V}$	1.6	3.3	5.4	ns	
		$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 2.3\text{ V to }2.7\text{ V}$	1.3	2.5	3.6	ns	
		$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 3.0\text{ V to }3.6\text{ V}$	1.2	2.1	2.9	ns	
		HIGH-to-LOW and LOW-to-HIGH propagation delay MR to Q	$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 0.8\text{ V}$	-	17.4	-	ns
$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 1.1\text{ V to }1.3\text{ V}$	2.4		5.2	9.7	ns		
$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 1.4\text{ V to }1.6\text{ V}$	2.3		3.8	4.9	ns		
$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 1.65\text{ V to }1.95\text{ V}$	1.8		3.1	4.9	ns		
$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 2.3\text{ V to }2.7\text{ V}$	1.8		2.6	3.6	ns		
$C_L = 5\text{ pF}$ ; $R_L = 1\text{ M}\Omega$ ; $V_{CC} = 3.0\text{ V to }3.6\text{ V}$	1.6		2.4	3.1	ns		
$f_{max}$	maximum input clock frequency		$V_{CC} = 3.0\text{ V to }3.6\text{ V}$ ; $C_L = 30\text{ pF}$	190	300	-	MHz
$C_I$	input capacitance		-	1.5	-	pF	
$C_{PD}$	power dissipation capacitance	$V_{CC} = 1.8\text{ V}$ ; $f = 1\text{ MHz}$	[1][2]	-	2.0	-	pF
		$V_{CC} = 3.3\text{ V}$ ; $f = 1\text{ MHz}$	[1][2]	-	2.7	-	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

[2] The condition is  $V_I = GND$  to  $V_{CC}$ .

### 4. Ordering information

Table 2: Ordering information

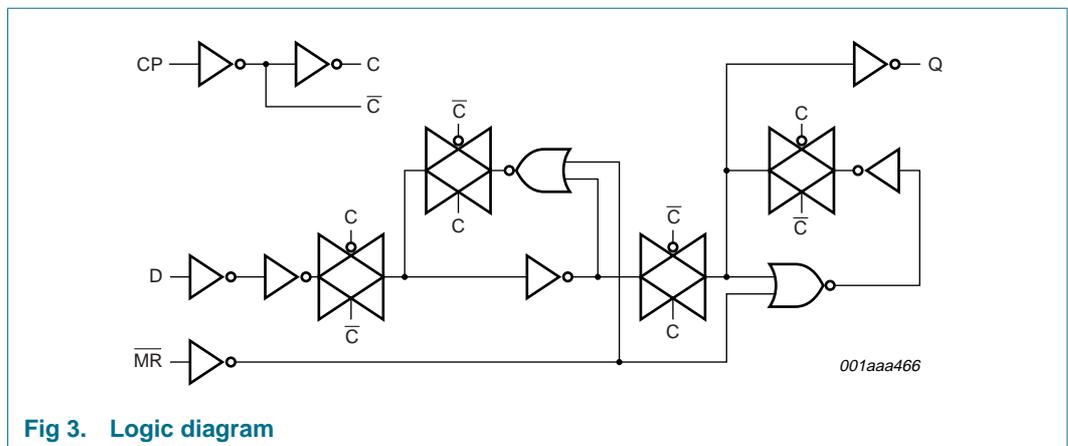
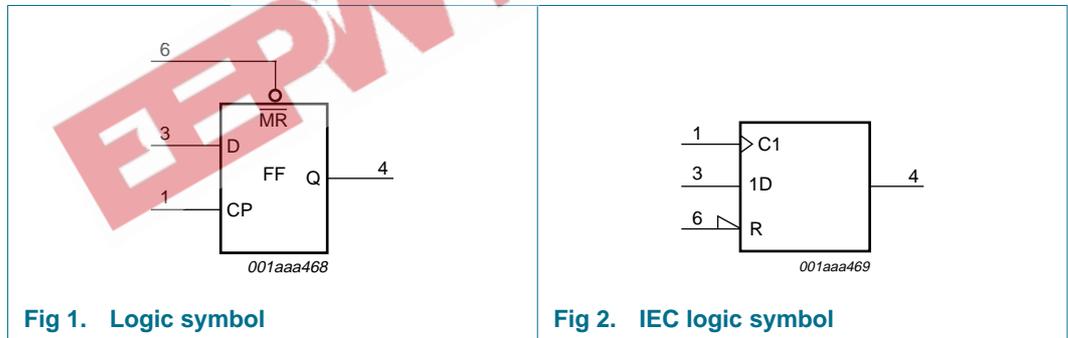
Type number	Package			Version
	Temperature range	Name	Description	
74AUP1G175GW	-40 °C to +125 °C	SC-88	plastic surface mounted package; 6 leads	SOT363
74AUP1G175GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74AUP1G175GF	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm	SOT891

### 5. Marking

Table 3: Marking

Type number	Marking code
74AUP1G175GW	aT
74AUP1G175GM	aT
74AUP1G175GF	aT

### 6. Functional diagram



7. Pinning information

7.1 Pinning

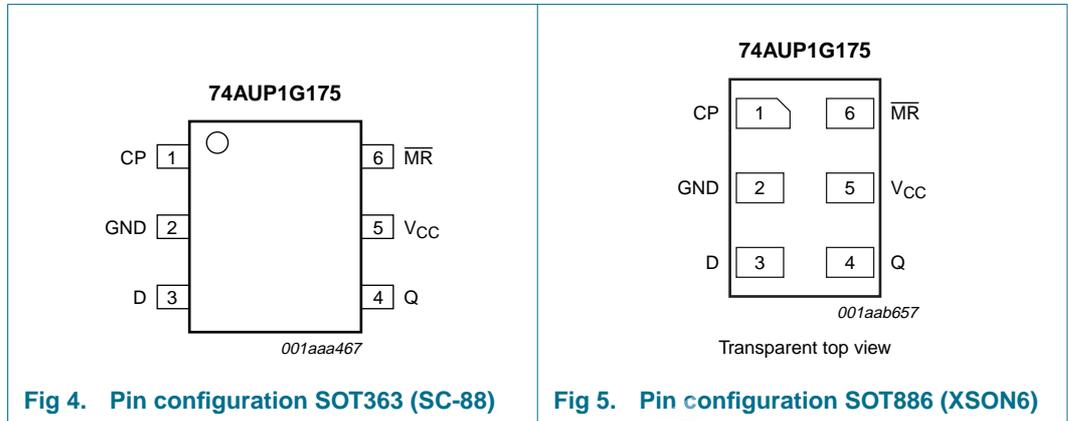


Fig 4. Pin configuration SOT363 (SC-88)

Fig 5. Pin configuration SOT886 (XSON6)

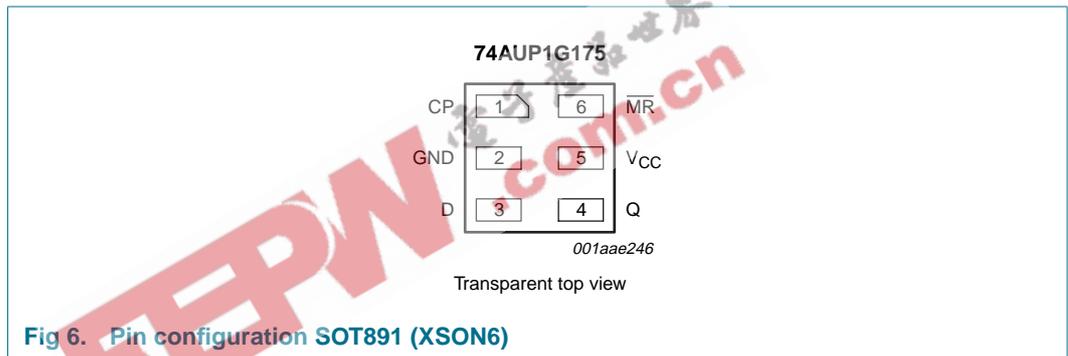


Fig 6. Pin configuration SOT891 (XSON6)

7.2 Pin description

Table 4: Pin description

Symbol	Pin	Description
CP	1	clock input (LOW-to-HIGH, edge-triggered)
GND	2	ground (0 V)
D	3	data input
Q	4	flip-flop output
V <sub>CC</sub>	5	supply voltage
MR	6	master reset input (active LOW)

## 8. Functional description

### 8.1 Function table

Table 5: Function table <sup>[1]</sup>

Operating mode	Input			Output
	MR	CP	D	Q
Reset (clear)	L	X	X	L
Load '1'	H	↑	h	H
Load '0'	H	↑	l	L

- [1] H = HIGH voltage level;  
h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition;  
L = LOW voltage level;  
l = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;  
↑ = LOW-to-HIGH CP transition;  
X = don't care.

## 9. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
$I_{IK}$	input clamping current	$V_I < 0$ V	-	-50	mA
$V_I$	input voltage		<sup>[1]</sup> -0.5	+4.6	V
$I_{OK}$	output clamping current	$V_O < 0$ V	-	-50	mA
$V_O$	output voltage	active mode and Power-down mode	<sup>[1]</sup> -0.5	+4.6	V
$I_O$	output current	$V_O = 0$ V to $V_{CC}$	-	±20	mA
$I_{CC}$	quiescent supply current		-	+50	mA
$I_{GND}$	ground current		-	-50	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C	<sup>[2]</sup> -	250	mW

- [1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- [2] For SC-88 packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.  
For XSON6 packages: above 45 °C the value of  $P_{tot}$  derates linearly with 2.4 mW/K.

## 10. Recommended operating conditions

**Table 7: Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		0.8	3.6	V
$V_I$	input voltage		0	3.6	V
$V_O$	output voltage	active mode	0	$V_{CC}$	V
		Power-down mode; $V_{CC} = 0$ V	0	3.6	V
$T_{amb}$	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 0.8$ V to 3.6 V	0	200	ns/V

## 11. Static characteristics

**Table 8: Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b><math>T_{amb} = 25</math> °C</b>						
$V_{IH}$	HIGH-state input voltage	$V_{CC} = 0.8$ V	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9$ V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3$ V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0$ V to 3.6 V	2.0	-	-	V
$V_{IL}$	LOW-state input voltage	$V_{CC} = 0.8$ V	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 0.9$ V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3$ V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0$ V to 3.6 V	-	-	0.9	V
$V_{OH}$	HIGH-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20$ $\mu$ A; $V_{CC} = 0.8$ V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_O = -1.1$ mA; $V_{CC} = 1.1$ V	$0.75 \times V_{CC}$	-	-	V
		$I_O = -1.7$ mA; $V_{CC} = 1.4$ V	1.11	-	-	V
		$I_O = -1.9$ mA; $V_{CC} = 1.65$ V	1.32	-	-	V
		$I_O = -2.3$ mA; $V_{CC} = 2.3$ V	2.05	-	-	V
		$I_O = -3.1$ mA; $V_{CC} = 2.3$ V	1.9	-	-	V
		$I_O = -2.7$ mA; $V_{CC} = 3.0$ V	2.72	-	-	V
$I_O = -4.0$ mA; $V_{CC} = 3.0$ V	2.6	-	-	V		

**Table 8: Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>OL</sub>	LOW-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.3 × V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.31	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.31	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.31	V
I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.44	V		
I <sub>I</sub>	input leakage current	V <sub>I</sub> = GND to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.1	μA
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V	-	-	±0.2	μA
ΔI <sub>OFF</sub>	additional power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 0.2 V	-	-	±0.2	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = GND or V <sub>CC</sub> ; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.5	μA
ΔI <sub>CC</sub>	additional quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 3.3 V	-	-	40	μA
C <sub>I</sub>	input capacitance	V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub>	-	0.8	-	pF
C <sub>O</sub>	output capacitance	V <sub>O</sub> = GND; V <sub>CC</sub> = 0 V	-	1.7	-	pF
<b>T<sub>amb</sub> = -40 °C to +85 °C</b>						
V <sub>IH</sub>	HIGH-state input voltage	V <sub>CC</sub> = 0.8 V	0.70 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.65 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	V
V <sub>IL</sub>	LOW-state input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
V <sub>OH</sub>	HIGH-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.7 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.03	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.30	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.97	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.85	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.67	-	-	V
I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.55	-	-	V		

**Table 8: Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{OL}$	LOW-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu\text{A}; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.1	V
		$I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V
		$I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.35	V
		$I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.45	V
$I_I$	input leakage current	$V_I = \text{GND to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	$\pm 0.5$	$\mu\text{A}$
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	$\pm 0.5$	$\mu\text{A}$
$\Delta I_{OFF}$	additional power-off leakage current	$V_I$ or $V_O = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	$\pm 0.6$	$\mu\text{A}$
$I_{CC}$	quiescent supply current	$V_I = \text{GND or } V_{CC}; I_O = 0 \text{ A}; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.9	$\mu\text{A}$
$\Delta I_{CC}$	additional quiescent supply current	$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$	-	-	50	$\mu\text{A}$
<b><math>T_{amb} = -40 \text{ }^\circ\text{C to } +125 \text{ }^\circ\text{C}</math></b>						
$V_{IH}$	HIGH-state input voltage	$V_{CC} = 0.8 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
$V_{IL}$	LOW-state input voltage	$V_{CC} = 0.8 \text{ V}$	-	-	$0.25 \times V_{CC}$	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V
$V_{OH}$	HIGH-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20 \mu\text{A}; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	$V_{CC} - 0.11$	-	-	V
		$I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6 \times V_{CC}$	-	-	V
		$I_O = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	V
		$I_O = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.17	-	-	V
		$I_O = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
		$I_O = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_O = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V

**Table 8: Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>OL</sub>	LOW-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.11	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.33 × V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.41	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.39	V
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.36	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.50	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.50	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = GND to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.75	μA
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V	-	-	±0.75	μA
ΔI <sub>OFF</sub>	additional power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 0.2 V	-	-	±0.75	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = GND or V <sub>CC</sub> ; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	1.4	μA
ΔI <sub>CC</sub>	additional quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 3.3 V	-	-	75	μA

[1] One input at V<sub>CC</sub> - 0.6 V, other input at V<sub>CC</sub> or GND.

## 12. Dynamic characteristics

**Table 9: Dynamic characteristics**

GND = 0 V; see [Figure 9](#)

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
<b>T<sub>amb</sub> = 25 °C; C<sub>L</sub> = 5 pF</b>						
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see <a href="#">Figure 7</a>				
		V <sub>CC</sub> = 0.8 V	-	21.1	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.4	5.9	11.7	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.0	4.1	6.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.6	3.3	5.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.3	2.5	3.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.2	2.1	2.9	ns
	HIGH-to-LOW and LOW-to-HIGH propagation delay $\overline{MR}$ to Q	see <a href="#">Figure 8</a>				
		V <sub>CC</sub> = 0.8 V	-	17.4	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.4	5.2	9.7	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.3	3.8	4.9	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.8	3.1	4.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.8	2.6	3.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.6	2.4	3.1	ns

Table 9: Dynamic characteristics ...continued

GND = 0 V; see Figure 9

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit	
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	50	-	MHz	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	200	-	MHz	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	345	-	MHz	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	435	-	MHz	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	550	-	MHz	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	615	-	MHz	
<b>T<sub>amb</sub> = 25 °C; C<sub>L</sub> = 10 pF</b>							
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	24.7	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.6	6.8	13.3	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.3	4.8	7.9	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.1	3.9	6.1	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	3.0	4.3	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.6	2.7	3.6	ns	
	HIGH-to-LOW and LOW-to-HIGH propagation delay MR to Q	see Figure 8					
		V <sub>CC</sub> = 0.8 V	-	21.0	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.6	6.2	11.5	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.5	4.4	5.9	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.5	3.7	5.7	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.1	3.2	4.3	ns	
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	50	-	MHz	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	190	-	MHz	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	320	-	MHz	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	420	-	MHz	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	485	-	MHz	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	550	-	MHz	

Table 9: Dynamic characteristics ...continued

GND = 0 V; see [Figure 9](#)

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit	
<b>T<sub>amb</sub> = 25 °C; C<sub>L</sub> = 15 pF</b>							
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see <a href="#">Figure 7</a>					
		V <sub>CC</sub> = 0.8 V	-	28.1	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.0	7.6	14.8	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.7	5.3	8.7	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.3	4.4	6.8	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.1	3.5	5.0	ns	
	HIGH-to-LOW and LOW-to-HIGH propagation delay $\overline{MR}$ to Q	see <a href="#">Figure 8</a>					
		V <sub>CC</sub> = 0.8 V	-	24.6	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.1	7.0	13.2	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.1	5.0	6.7	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.6	4.3	6.5	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.6	3.7	5.0	ns	
f <sub>max</sub>	maximum input clock frequency CP	see <a href="#">Figure 7</a>					
		V <sub>CC</sub> = 0.8 V	-	50	-	MHz	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	180	-	MHz	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	300	-	MHz	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	405	-	MHz	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	420	-	MHz	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	480	-	MHz	
<b>T<sub>amb</sub> = 25 °C; C<sub>L</sub> = 30 pF</b>							
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see <a href="#">Figure 7</a>					
		V <sub>CC</sub> = 0.8 V	-	38.4	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.6	9.8	19.5	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.3	6.9	11.2	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.1	5.7	8.8	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.0	4.6	6.4	ns	
	HIGH-to-LOW and LOW-to-HIGH propagation delay $\overline{MR}$ to Q	see <a href="#">Figure 8</a>					
		V <sub>CC</sub> = 0.8 V	-	35.1	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.9	9.3	18.0	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.9	6.6	8.7	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.6	5.6	8.6	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.5	4.8	6.4	ns	
V <sub>CC</sub> = 3.0 V to 3.6 V	3.3	4.6	5.7	ns			

Table 9: Dynamic characteristics ...continued

GND = 0 V; see Figure 9

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit	
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	35	-	MHz	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	130	-	MHz	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	200	-	MHz	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	240	-	MHz	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	275	-	MHz	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	300	-	MHz	
<b>T<sub>amb</sub> = 25 °C</b>							
t <sub>w</sub>	pulse width HIGH or LOW CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	5.25	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	1.6	-	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	1.0	-	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	0.75	-	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.6	-	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.55	-	ns	
	pulse width LOW $\overline{\text{MR}}$	see Figure 8					
		V <sub>CC</sub> = 0.8 V	-	9.0	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	3.0	-	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	1.75	-	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	1.35	-	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.9	-	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.8	-	ns	
t <sub>rem</sub>	removal time $\overline{\text{MR}}$	see Figure 8					
		V <sub>CC</sub> = 0.8 V	-	-	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	-1.1	-	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	-2.0	-	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-0.5	-	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-0.9	-	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-1.0	-	ns	
t <sub>su(H)</sub>	set-up time HIGH D to CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	-	-	ns	
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	0.5	-	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	0.4	-	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	0.5	-	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.3	-	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.2	-	ns	

**Table 9: Dynamic characteristics ...continued**GND = 0 V; see [Figure 9](#)

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
$t_{su(L)}$	set-up time LOW D to CP	see <a href="#">Figure 7</a>				
		$V_{CC} = 0.8\text{ V}$	-	-	-	ns
		$V_{CC} = 1.1\text{ V to }1.3\text{ V}$	-	0.8	-	ns
		$V_{CC} = 1.4\text{ V to }1.6\text{ V}$	-	0.6	-	ns
		$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	-	0.4	-	ns
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	-	0.4	-	ns
		$V_{CC} = 3.0\text{ V to }3.6\text{ V}$	-	0.5	-	ns
$t_h$	hold time D to CP	see <a href="#">Figure 7</a>		-		
		$V_{CC} = 0.8\text{ V}$	-	-	-	ns
		$V_{CC} = 1.1\text{ V to }1.3\text{ V}$	-	-0.7	-	ns
		$V_{CC} = 1.4\text{ V to }1.6\text{ V}$	-	-0.5	-	ns
		$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	-	-0.5	-	ns
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	-	-0.3	-	ns
		$V_{CC} = 3.0\text{ V to }3.6\text{ V}$	-	-0.4	-	ns
$C_{PD}$	power dissipation capacitance	$f = 1\text{ MHz}$				
		$V_{CC} = 0.8\text{ V}$	-	1.8	-	pF
		$V_{CC} = 1.1\text{ V to }1.3\text{ V}$	-	1.9	-	pF
		$V_{CC} = 1.4\text{ V to }1.6\text{ V}$	-	1.9	-	pF
		$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	-	2.0	-	pF
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	-	2.3	-	pF
		$V_{CC} = 3.0\text{ V to }3.6\text{ V}$	-	2.7	-	pF

[1] All typical values are measured at nominal  $V_{CC}$ .[2]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where: $f_i$  = input frequency in MHz; $f_o$  = output frequency in MHz; $C_L$  = output load capacitance in pF; $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.[3] The condition is  $V_I = \text{GND to } V_{CC}$ .

Table 10: Dynamic characteristics

GND = 0 V; see Figure 9

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
<b>C<sub>L</sub> = 5 pF</b>							
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see Figure 7					
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.2	11.9	2.2	12.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.8	7.3	1.8	7.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.3	5.9	1.3	6.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.1	4.0	1.1	4.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.3	1.0	3.5	ns
	HIGH-to-LOW and LOW-to-HIGH propagation delay MR to Q	see Figure 8					
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.2	10.0	2.2	12.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.1	6.4	2.1	6.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.7	5.4	1.7	5.6	ns
V <sub>CC</sub> = 2.3 V to 2.7 V		1.5	4.0	1.5	4.0	ns	
	V <sub>CC</sub> = 3.0 V to 3.6 V	1.3	3.3	1.3	3.6	ns	
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V	170	-	-	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V	310	-	-	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V	400	-	-	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V	490	-	-	-	MHz
	V <sub>CC</sub> = 3.0 V to 3.6 V	550	-	-	-	MHz	
<b>C<sub>L</sub> = 10 pF</b>							
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see Figure 7					
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.4	13.6	2.4	13.6	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.0	8.4	2.0	8.7	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.8	6.6	1.8	6.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.5	4.7	1.5	5.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.3	4.0	1.3	4.2	ns
	HIGH-to-LOW and LOW-to-HIGH propagation delay MR to Q	see Figure 8					
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.6	11.7	2.6	13.6	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.4	7.6	2.4	7.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.2	6.3	2.2	6.3	ns
V <sub>CC</sub> = 2.3 V to 2.7 V		1.9	4.7	1.9	4.9	ns	
	V <sub>CC</sub> = 3.0 V to 3.6 V	1.8	4.1	1.8	4.3	ns	

Table 10: Dynamic characteristics ...continued

GND = 0 V; see Figure 9

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V	150	-	-	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V	280	-	-	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V	310	-	-	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V	370	-	-	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	410	-	-	-	MHz
<b>C<sub>L</sub> = 15 pF</b>							
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see Figure 7					
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.8	15.2	2.8	15.4	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.3	9.4	2.3	9.9	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.1	7.4	2.1	7.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.9	5.3	1.9	5.6	ns
	HIGH-to-LOW and LOW-to-HIGH propagation delay MR to Q	see Figure 8					
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.9	13.5	2.9	15.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.6	8.6	2.6	9.1	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.5	7.2	2.5	7.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.2	5.4	2.2	5.5	ns
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7					
		V <sub>CC</sub> = 0.8 V	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V	120	-	-	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V	190	-	-	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V	240	-	-	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V	300	-	-	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	320	-	-	-	MHz

Table 10: Dynamic characteristics ...continued

GND = 0 V; see Figure 9

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Max	Min	Max		
<b>C<sub>L</sub> = 30 pF</b>								
t <sub>PHL</sub> , t <sub>PLH</sub>	HIGH-to-LOW and LOW-to-HIGH propagation delay CP to Q	see Figure 7						
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.4	20.6	3.4	21.0	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.2	12.4	3.2	13.0	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.9	9.6	2.9	10.2	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.6	6.9	2.6	7.3	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.5	6.5	2.5	6.9	ns	
	HIGH-to-LOW and LOW-to-HIGH propagation delay MR to Q	see Figure 8						
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.7	18.6	3.7	19.8	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.6	11.6	3.6	12.2	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.4	9.6	3.4	9.7	ns	
V <sub>CC</sub> = 2.3 V to 2.7 V		2.9	7.2	2.9	7.2	ns		
	V <sub>CC</sub> = 3.0 V to 3.6 V	3.1	6.4	3.1	6.9	ns		
f <sub>max</sub>	maximum input clock frequency CP	see Figure 7						
		V <sub>CC</sub> = 0.8 V	-	-	-	-	MHz	
		V <sub>CC</sub> = 1.1 V to 1.3 V	70	-	-	-	MHz	
		V <sub>CC</sub> = 1.4 V to 1.6 V	120	-	-	-	MHz	
		V <sub>CC</sub> = 1.65 V to 1.95 V	150	-	-	-	MHz	
		V <sub>CC</sub> = 2.3 V to 2.7 V	190	-	-	-	MHz	
		V <sub>CC</sub> = 3.0 V to 3.6 V	200	-	-	-	MHz	
<b>C<sub>L</sub> = 5 pF, 10 pF, 15 pF, 30 pF</b>								
t <sub>w</sub>	pulse width HIGH or LOW CP	see Figure 7						
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.5	-	1.5	-	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	0.9	-	0.9	-	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.7	-	0.7	-	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.4	-	0.4	-	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.4	-	0.4	-	ns	
	pulse width LOW MR	see Figure 8						
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.9	-	4.9	-	ns	
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.5	-	2.5	-	ns	
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.8	-	1.8	-	ns	
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.1	-	1.1	-	ns	
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.8	-	0.8	-	ns	
		t <sub>rem</sub>	removal time MR	see Figure 8				
				V <sub>CC</sub> = 1.1 V to 1.3 V	-1.2	-	-1.2	-
V <sub>CC</sub> = 1.4 V to 1.6 V	-0.8			-	-0.8	-	ns	
V <sub>CC</sub> = 1.65 V to 1.95 V	-0.7			-	-0.7	-	ns	
V <sub>CC</sub> = 2.3 V to 2.7 V	-0.4			-	-0.4	-	ns	
V <sub>CC</sub> = 3.0 V to 3.6 V	-0.2			-	-0.2	-	ns	

Table 10: Dynamic characteristics ...continued

GND = 0 V; see [Figure 9](#)

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
$t_{su(H)}$	set-up time HIGH D to CP	see <a href="#">Figure 7</a>					
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	1.2	-	1.2	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	0.8	-	0.8	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.6	-	0.6	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.5	-	0.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.5	-	0.5	-	ns
$t_{su(L)}$	set-up time LOW D to CP	see <a href="#">Figure 7</a>					
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	1.7	-	1.7	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	1.1	-	1.1	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.9	-	0.9	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.9	-	0.9	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.9	-	0.9	-	ns
$t_h$	hold time D to CP	see <a href="#">Figure 7</a>					
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	0.2	-	0.2	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	0	-	0	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0	-	0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0	-	0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0	-	0	-	ns

13. Waveforms

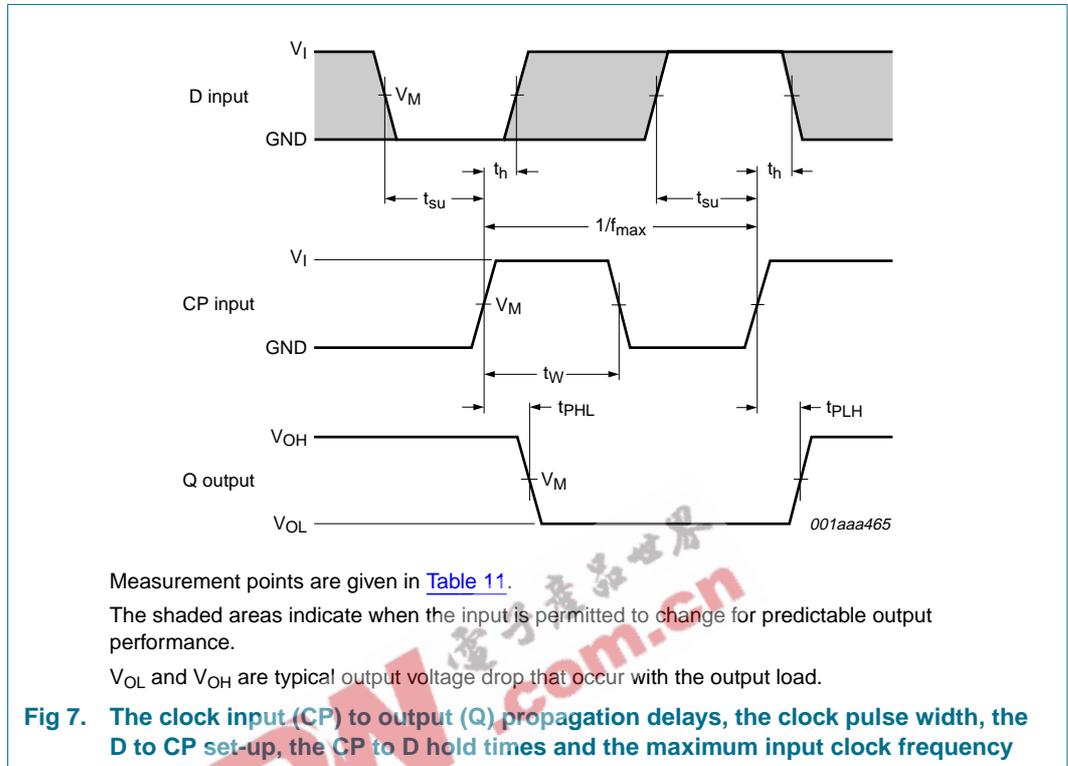


Table 11: Measurement points

Supply voltage	Output	Input		
$V_{CC}$	$V_M$	$V_M$	$V_I$	$t_r = t_f$
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{CC}$	$\leq 3.0$ ns

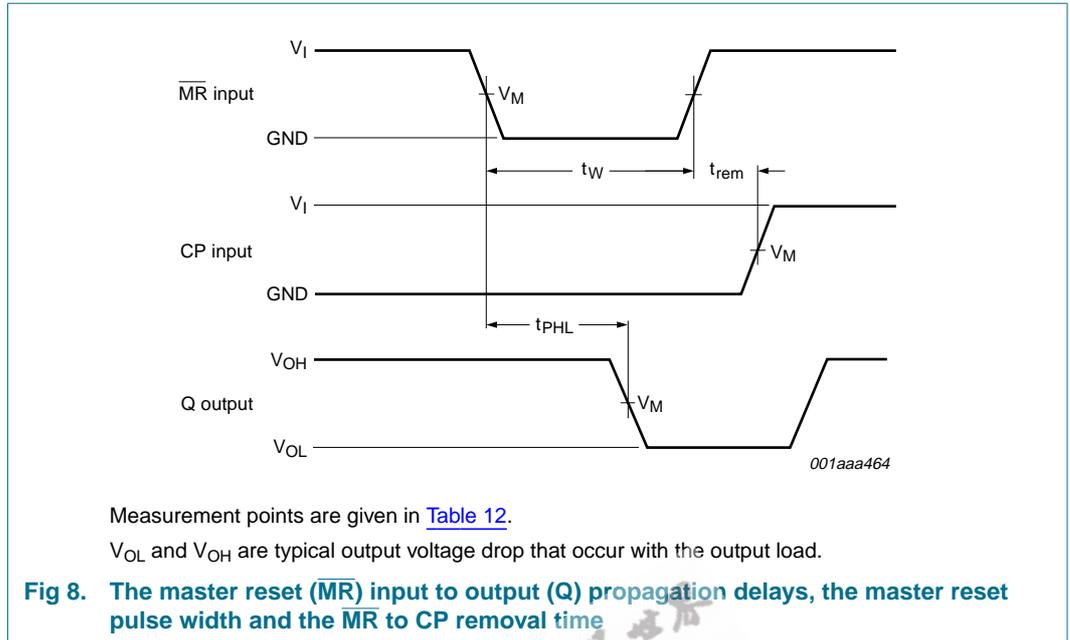
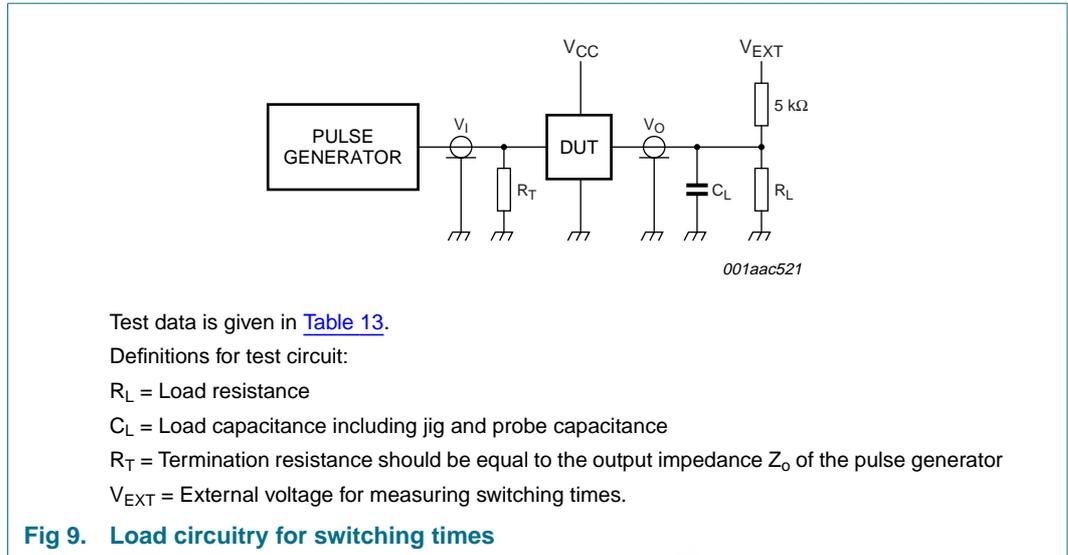


Table 12: Measurement points

Supply voltage	Output	Input		
$V_{CC}$	$V_M$	$V_M$	$V_I$	$t_r = t_f$
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{CC}$	$\leq 3.0$ ns



**Fig 9. Load circuitry for switching times**

**Table 13: Test data**

Supply voltage	Load		$V_{EXT}$		
$V_{CC}$	$C_L$	$R_L$ [1]	$t_{PLH}, t_{PHL}$	$t_{PZH}, t_{PHZ}$	$t_{PZL}, t_{PLZ}$
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times  $R_L = 5 \text{ k}\Omega$ , for measuring propagation delays, setup and hold times and pulse width  $R_L = 1 \text{ M}\Omega$ .

14. Package outline

Plastic surface mounted package; 6 leads

SOT363

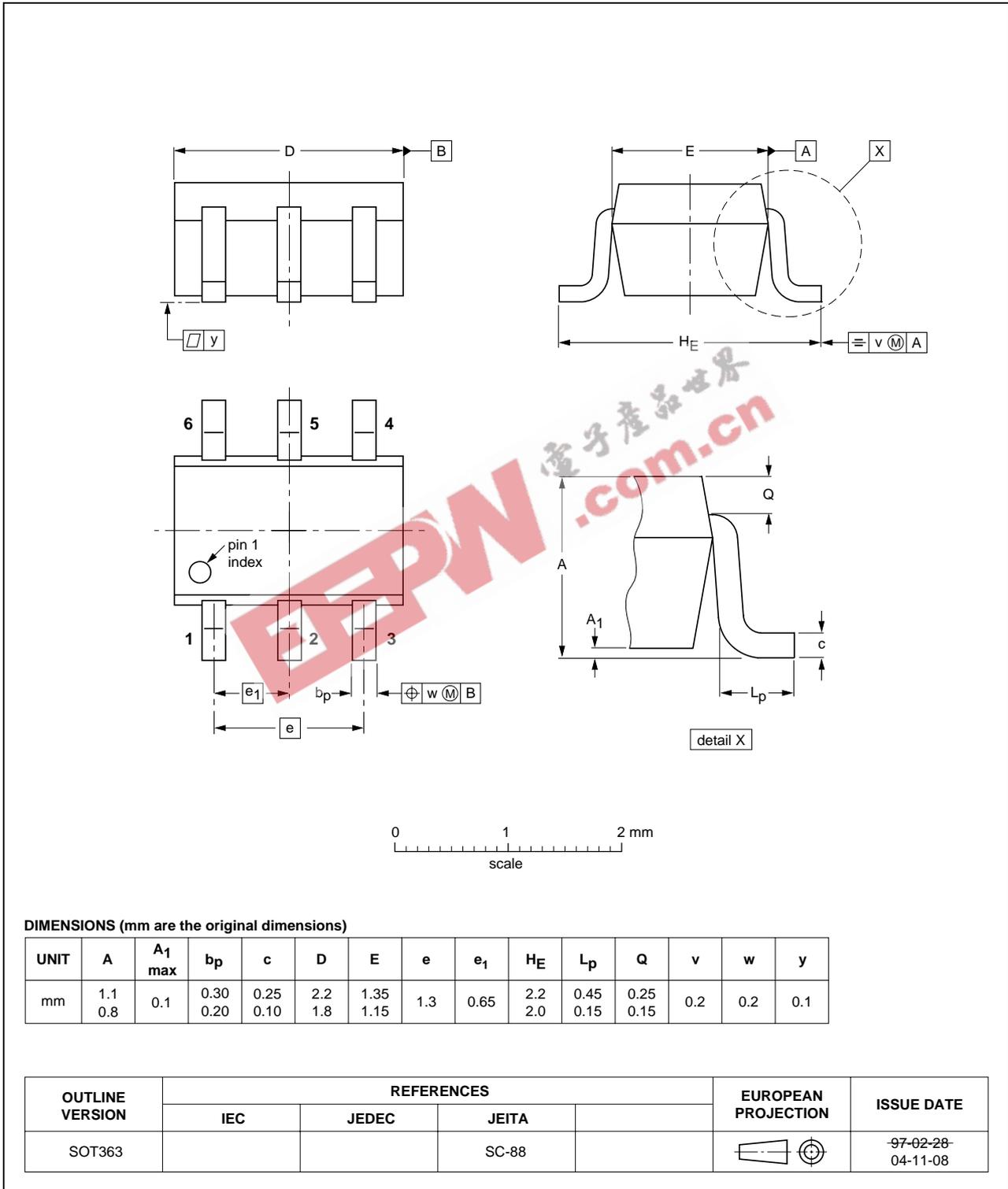


Fig 10. Package outline SOT363 (SC-88)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

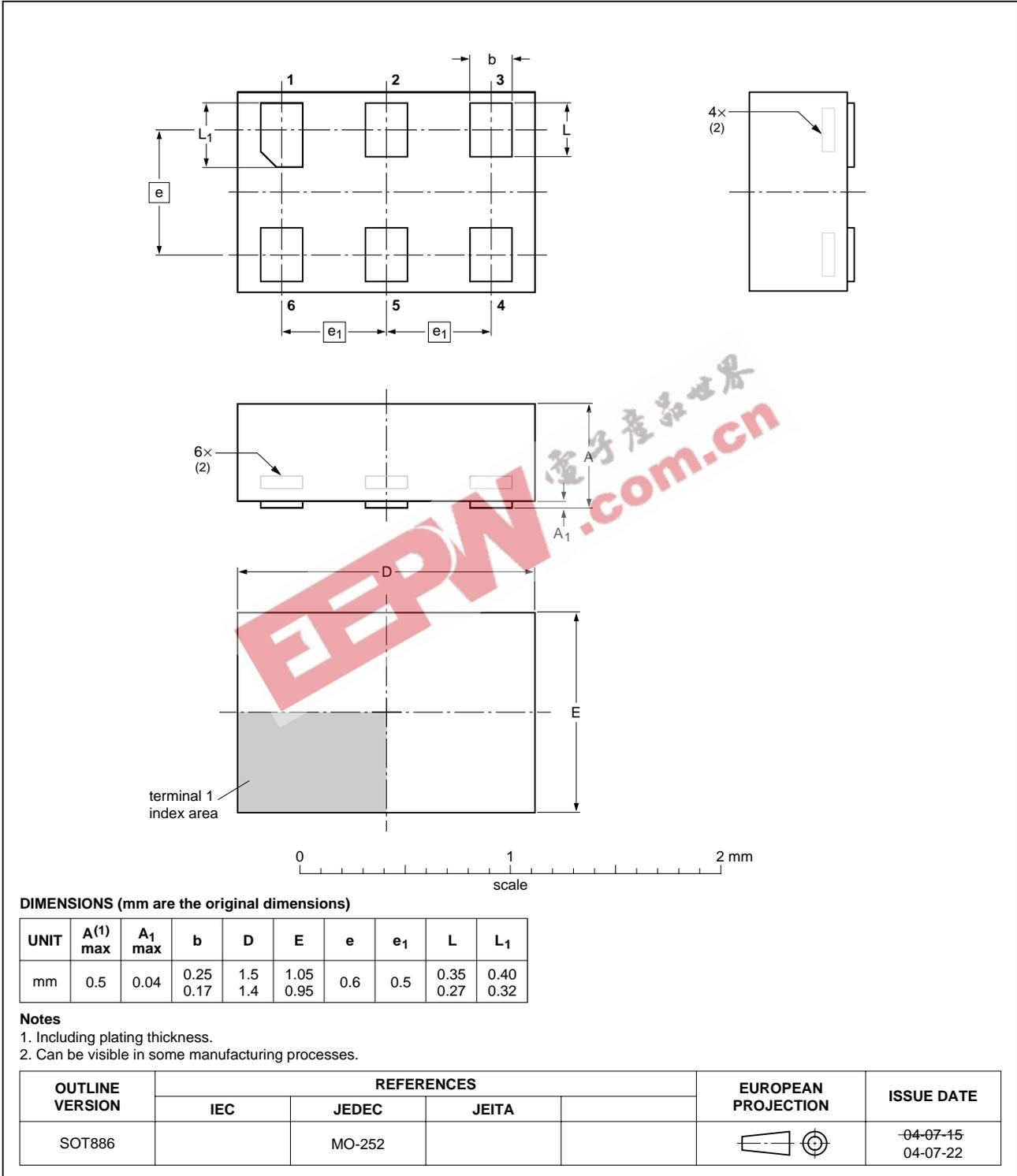


Fig 11. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

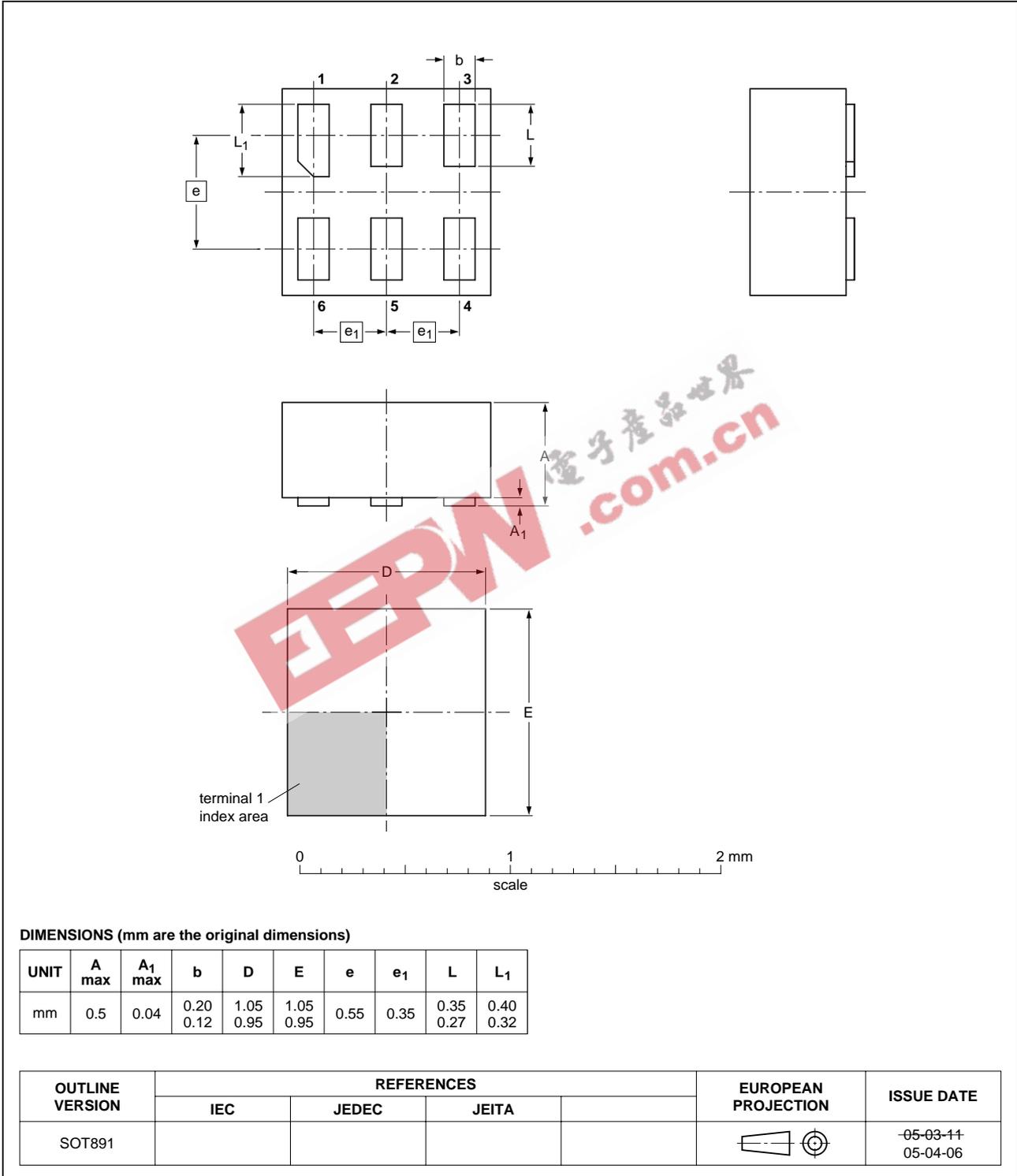


Fig 12. Package outline SOT891 (XSON6)

## 15. Abbreviations

Table 14: Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor Transistor Logic

## 16. Revision history

Table 15: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
74AUP1G175_1	20060327	Preliminary data sheet	-	-	-

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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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